

01-22-02 A



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Patent Application of: Krishna Seshan et al.

WIRE-BOND PROCESS FLOW FOR COPPER METAL-SIX, STRUCTURES ACHIEVED
THEREBY, AND TESTING METHOD

Attorney Docket No.: 884.659US1

010/052089 PRO
01/15/02

PATENT APPLICATION TRANSMITTAL

BOX PATENT APPLICATION

Commissioner for Patents

Washington, D.C. 20231

We are transmitting herewith the following attached items and information (as indicated with an "X"):

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Utility Patent Application under 37 CFR § 1.53(b) comprising:

Specification (26 pgs, including claims numbered 1 through 23 and a 1 page Abstract).

Formal Drawing(s) (4 sheets).

Signed Combined Declaration and Power of Attorney (8 pgs).

Check in the amount of \$794.00 to pay the filing fee.

Assignment of the invention to Intel Corporation (4 pgs) and Recordation Form Cover Sheet.

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	No. Filed	No. Extra	Rate	Fee
TOTAL CLAIMS	23 - 20 =	3	x 18 =	\$54.00
INDEPENDENT CLAIMS	3 - 3 =	0	x 84 =	\$0.00
[] MULTIPLE DEPENDENT CLAIMS PRESENTED				\$0.00
BASIC FEE				\$740.00
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